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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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## SPECIFICATION

Model No. : **SGGP.25.4.A.02**

Product Name : GPS/GLONASS/GALILEO SMT Patch Antenna

Features : 25mm\*25mm\*4.5mm  
Single Feed SMT Mount  
GPS/GALILEO: 1575MHz  
GLONASS: 1602MHz  
Patent pending  
RoHS Compliant



## 1. Introduction

This ceramic 25mm GPS/GLONASS/GALILEO patch antenna is mounted via SMT process and has been pre-tuned for a 50\*50mm ground plane. Custom part no's tuned for different ground-plane or layout positions and taking into account the specific conditions in your device can be created and supplied by Taoglas.

## 2. Specification

Original Patch Specification tested on 50\*50mm ground plane

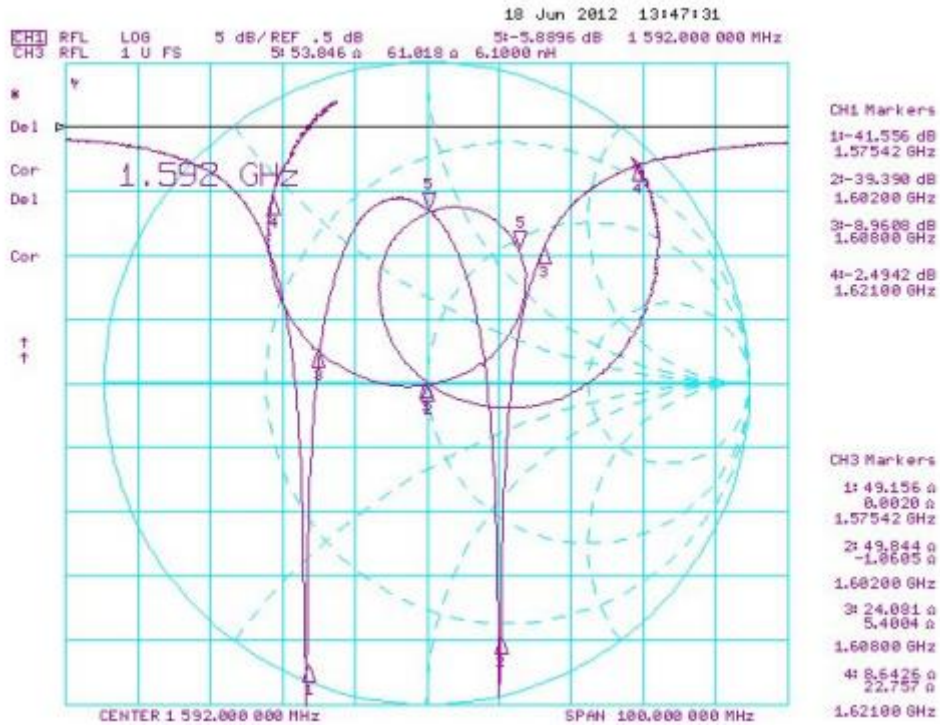
No	Parameter	Specification	Notes
1	Range of Receiving Frequency	GPS/GALILEO: 1575.42 MHz $\pm$ 1.023 MHz GLONASS: 1602 $\pm$ 5 MHz	
2	Center Frequency	1592 $\pm$ 3MHz	With 50*50mm ground plane
3	Bandwidth	8MHz min	Return Loss <-10 dB
4	VSWR	1.5 max	Center Frequency
5	Gain at Zenith	GPS/GALILEO: -0.14dBic typ. GLONASS: 1.75dBic typ.	
8	Polarization	RHCP	
9	Impedance	50 Ohms	
10	Frequency Temperature Coefficient ( $\tau_f$ )	0 $\pm$ 20ppm / oC	-40°C to +85°C
11	Operating Temperature -40°C to +85°C		

\*\*Changes in user groundplane and environment will offset centre frequency



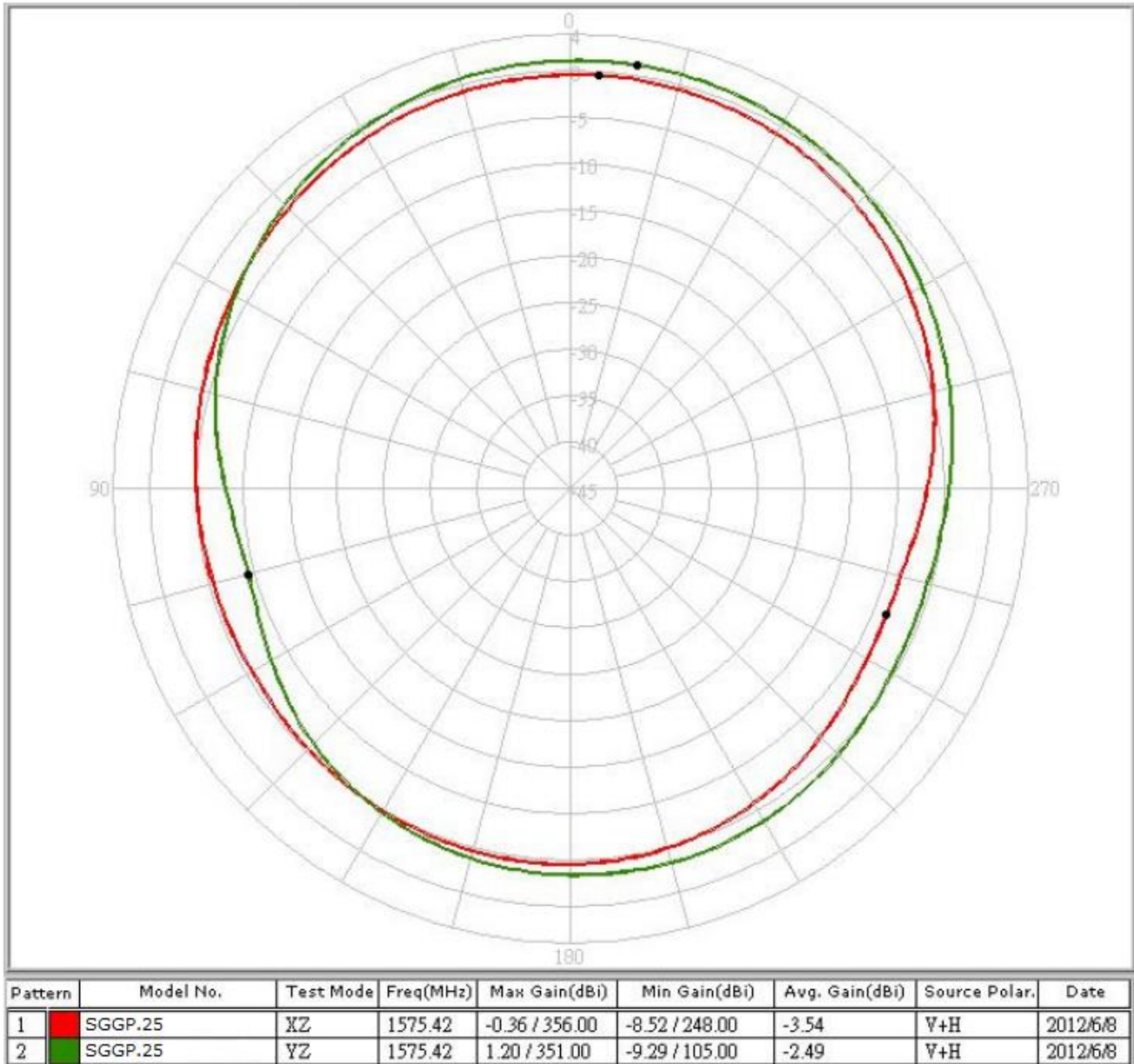
### 3. Electrical Specifications

#### 3.1. Return Loss, SWR, Impedance, measured on the test fixture



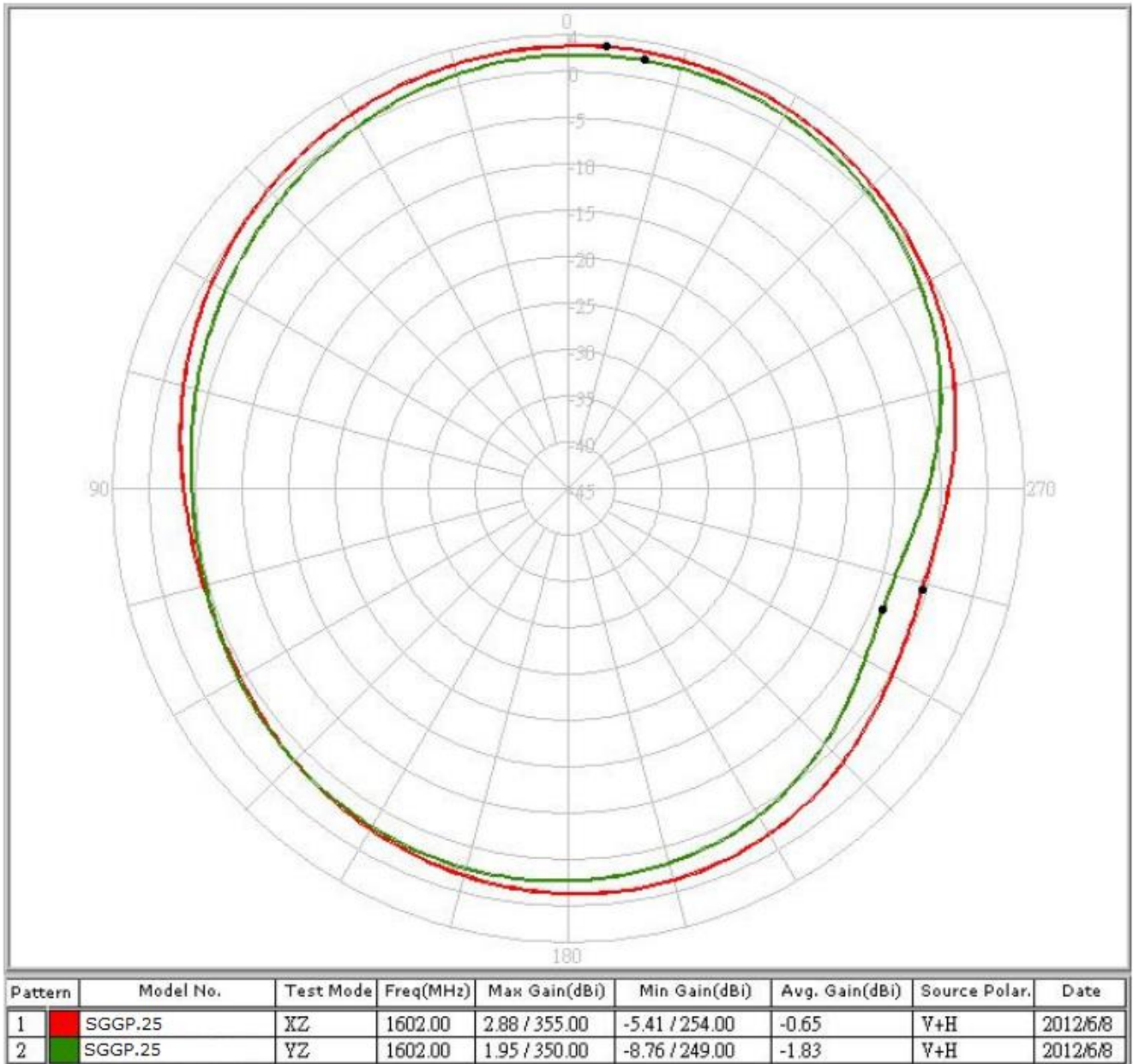
## 4. Radiation Patterns

### 4.1. 1575MHz



1575.4 MHz XZ+YZ-Plane

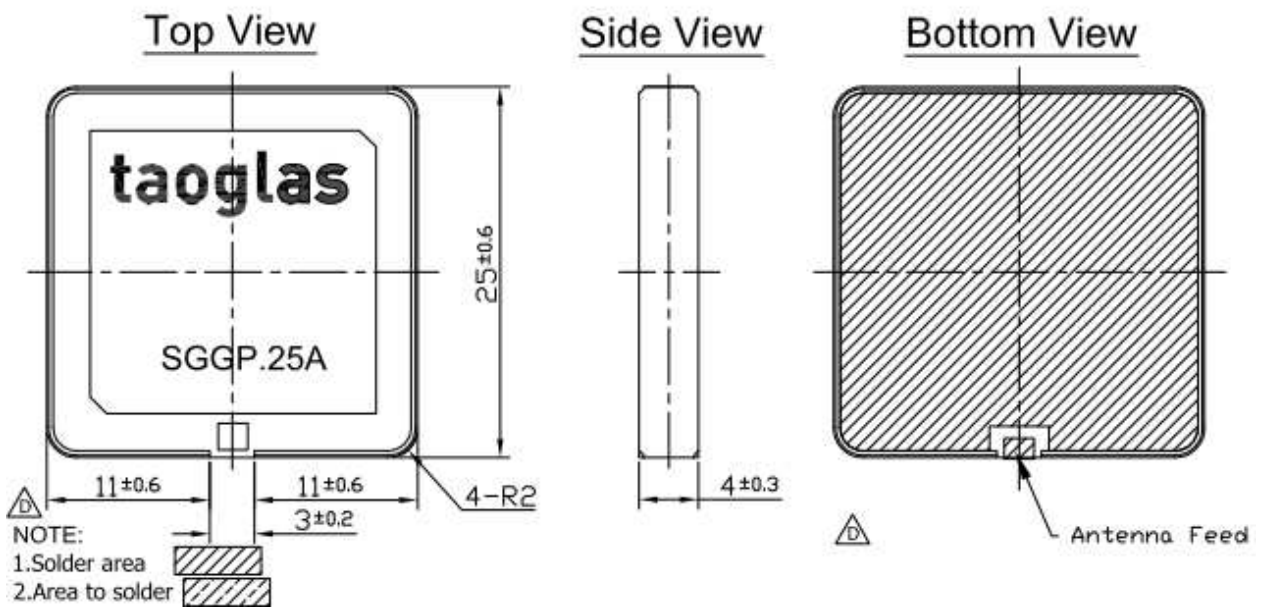
## 4.2. 1602MHz



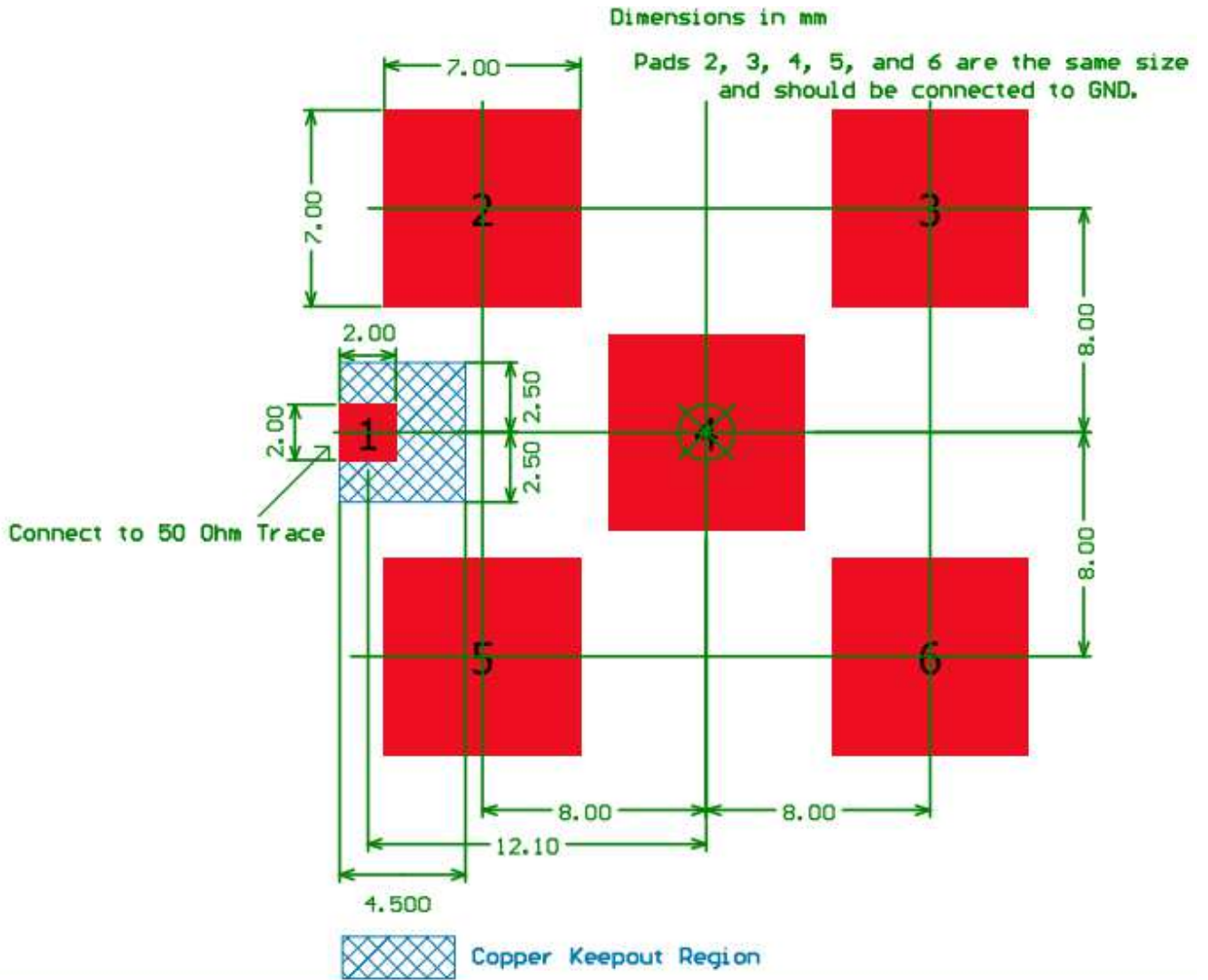
1602.0 MHz XZ+YZ-Plane

## 5. Mechanical Specifications

### 5.1. Antenna Dimensions and Drawing

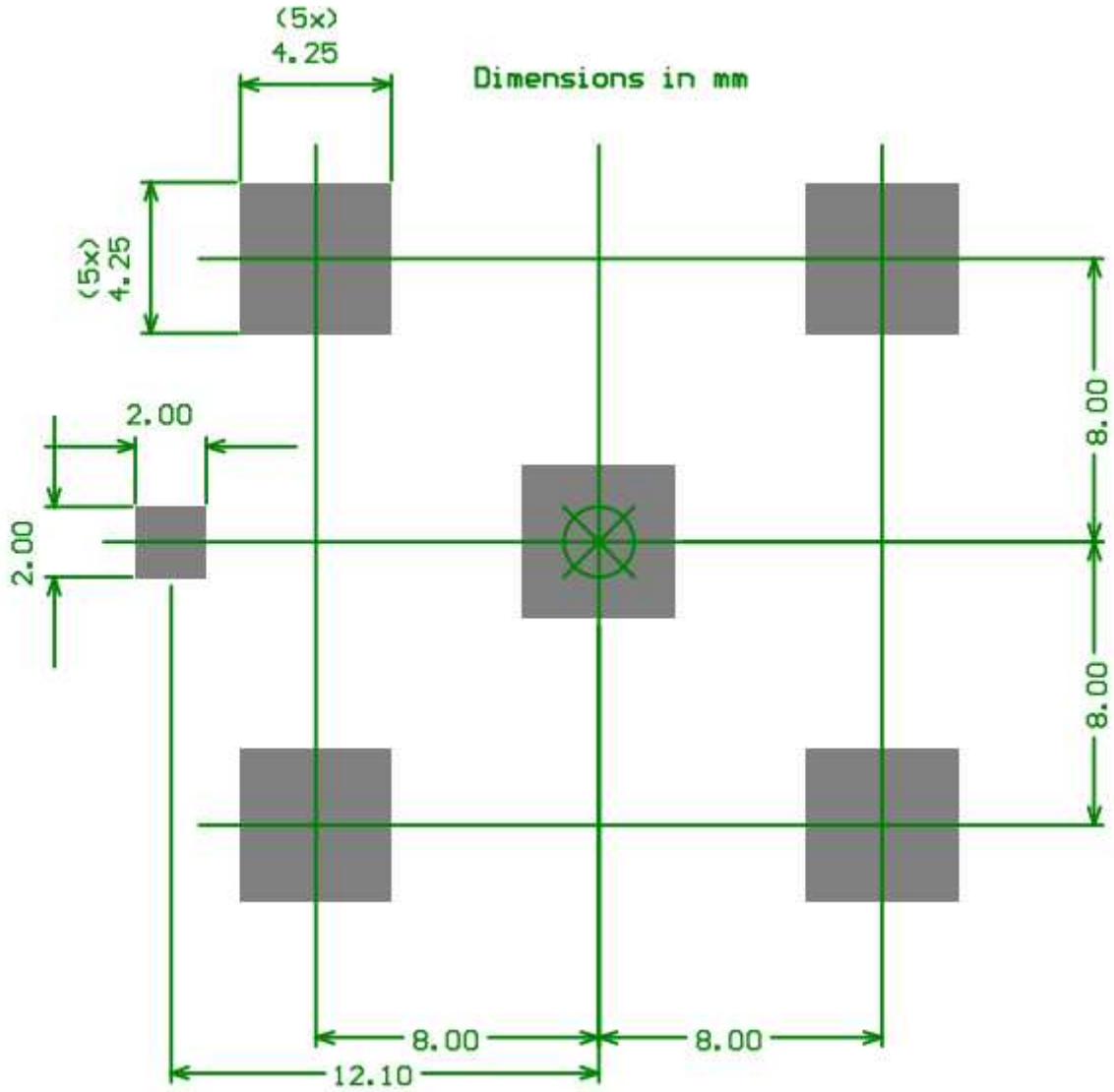


## 5.2. Footprint Copper Keepout Area

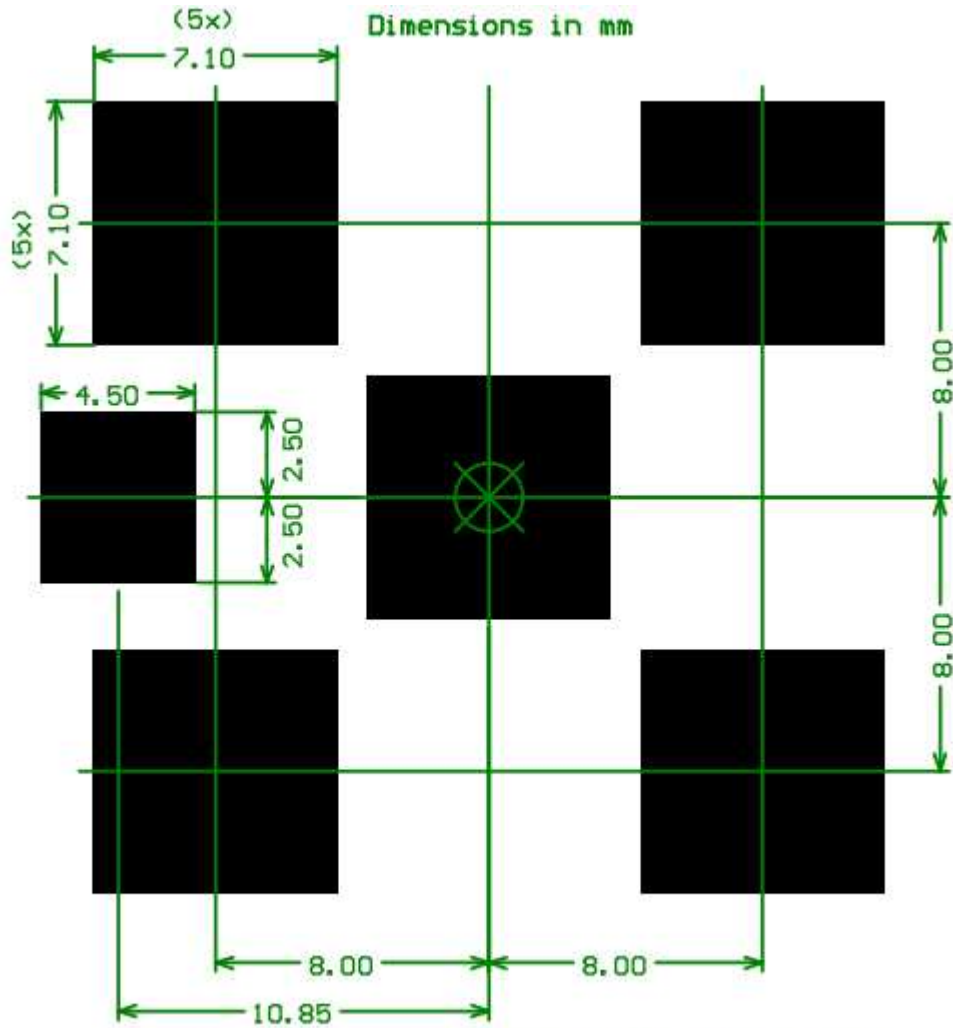




### 5.3. Paste Area

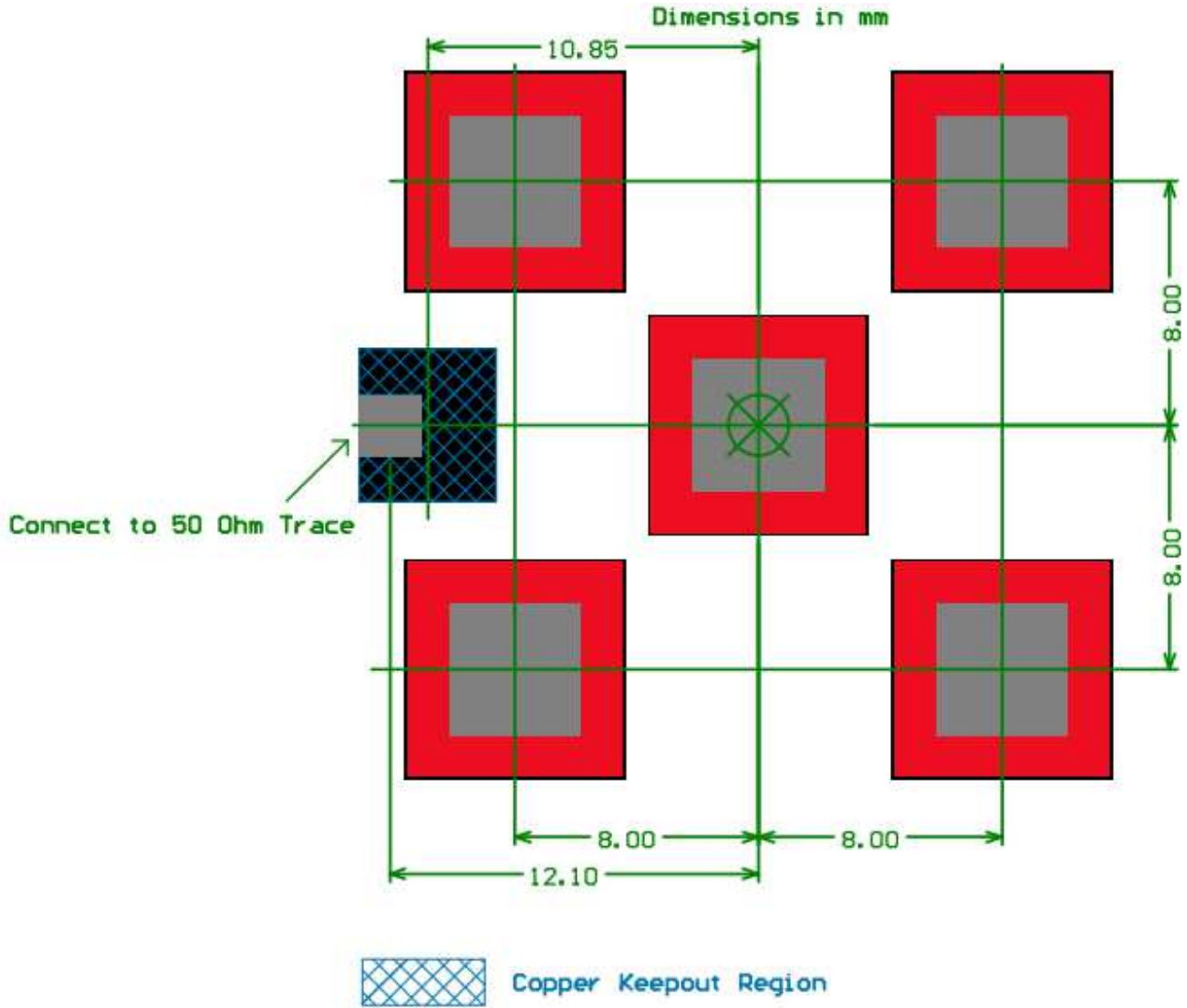


### 5.4. Soder Mask (Negative)

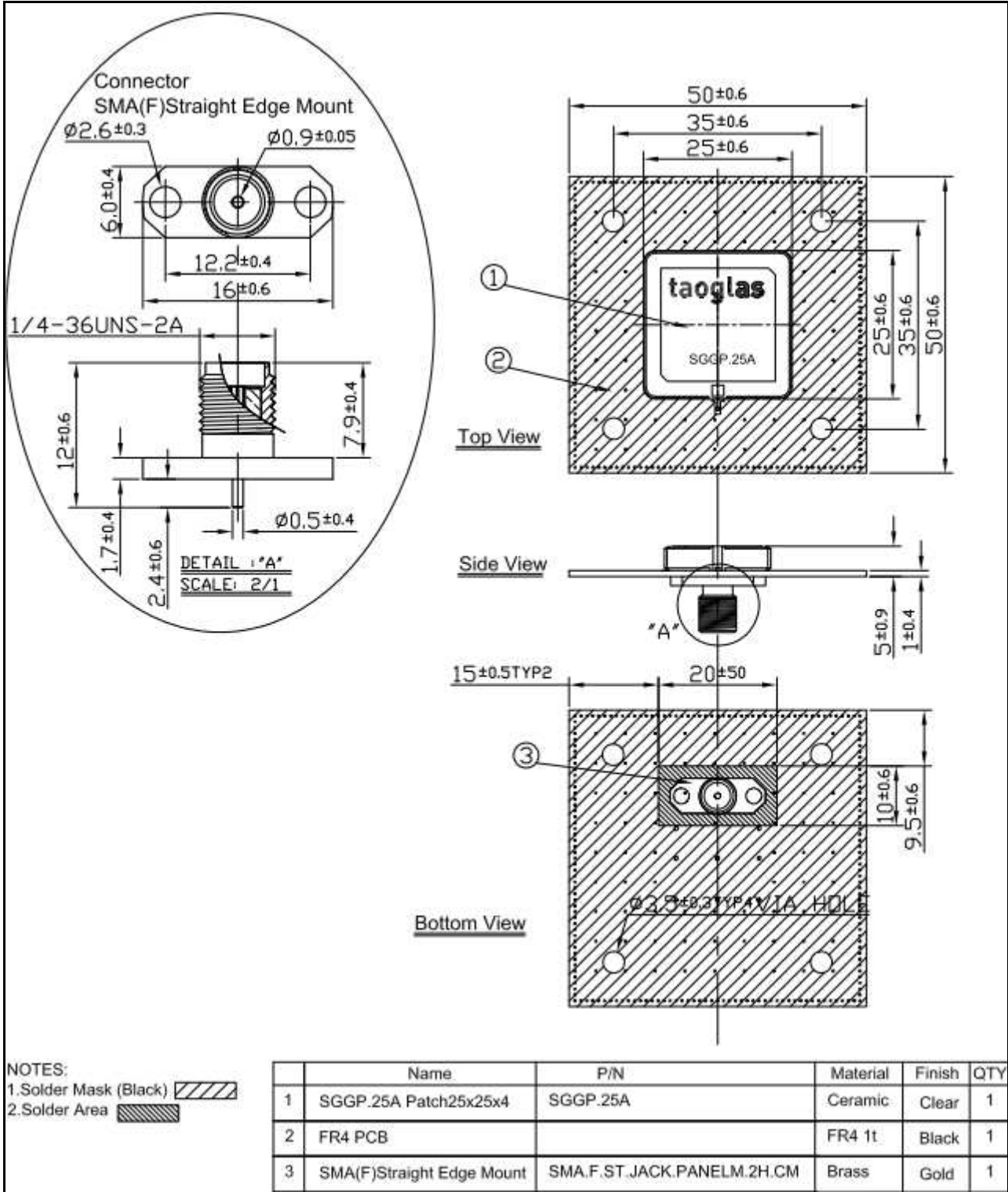


This drawing is a negative of solder mask.  
Black regions are anti-mask.

### 5.5. Footprint Composite

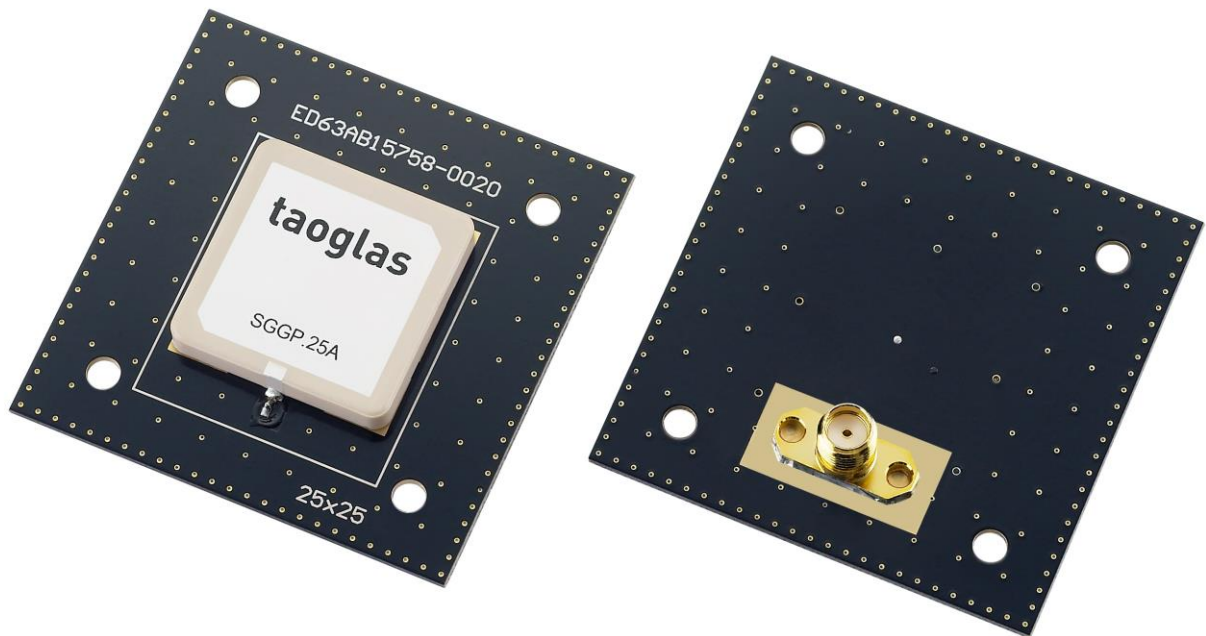


## 5.6. Test Jig and Dimension SGGPD.25A





## 5.7. SGGPD.25A

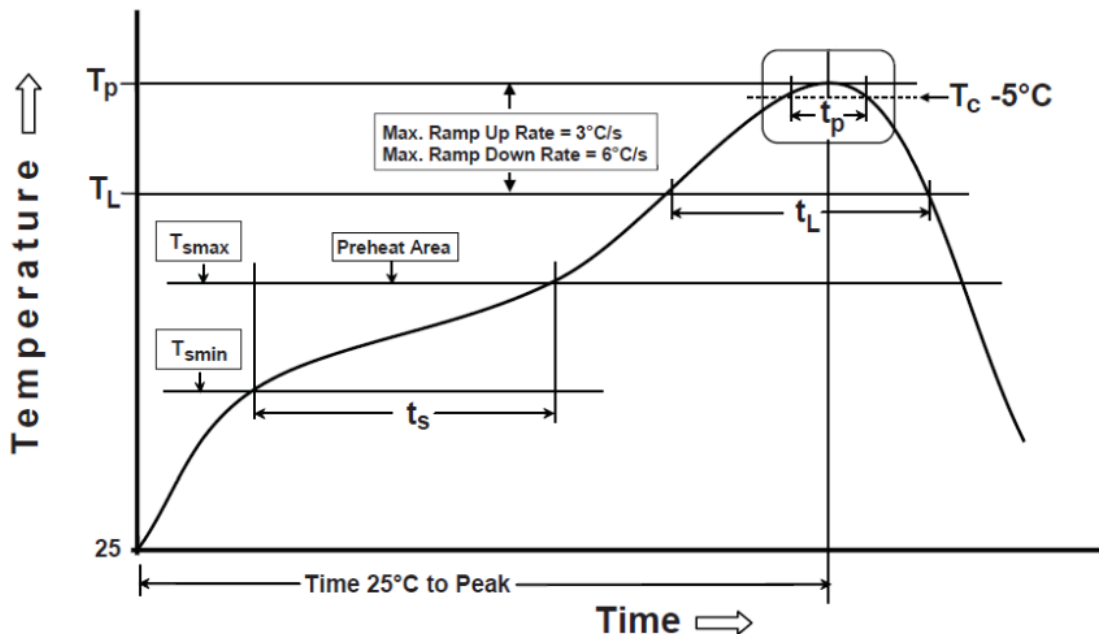


## 6. Recommended Reflow Soldering Profile

SGGP.25A can be assembled following Pb-free assembly. According to the Standard IPC/JEDEC J-STD-020C, the temperature profile suggested is as follow:

Phase	Profile Features	Pb-Free Assembly (SnAgCu)
PREHEAT	Temperature Min( $T_{smin}$ )	150°C
	Temperature Max( $T_{smax}$ )	200°C
	Time( $t_s$ ) from ( $T_{smin}$ to $T_{smax}$ )	60-120 seconds
RAMP-UP	Avg. Ramp-up Rate ( $T_{smax}$ to TP)	3°C/second(max)
REFLOW	Temperature( $T_L$ )	217°C
	Total Time above $T_L$ ( $t_L$ )	30-100 seconds
PEAK	Temperature( $T_P$ )	260°C
	Time( $t_p$ )	2-5 seconds
RAMP-DOWN	Rate	3°C/second(max)
Time from 25°C to Peak Temperature		8 minutes max.
Composition of solder paste		96.5Sn/3Ag/0.5Cu
Solder Paste Model		SHENMAO PF606-P26

The graphic shows temperature profile for component assembly process in reflow ovens

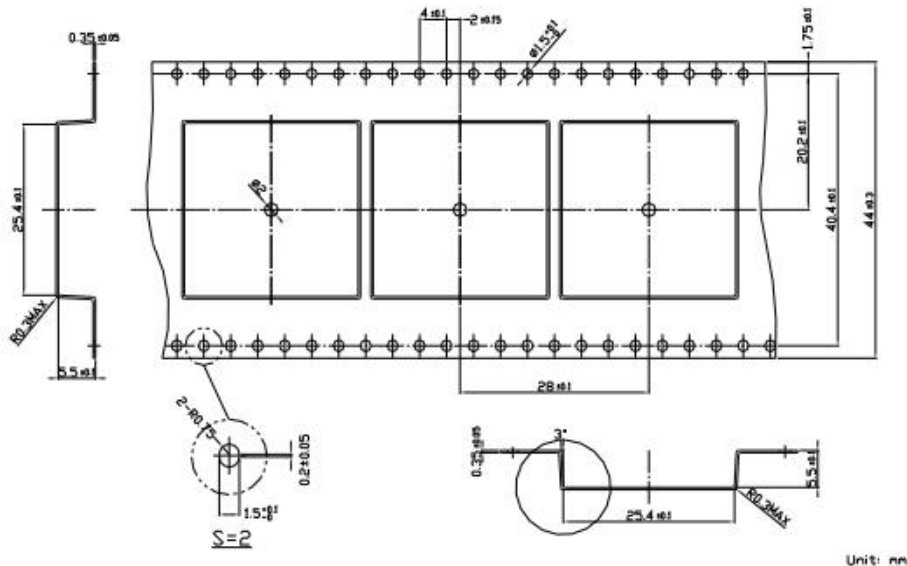
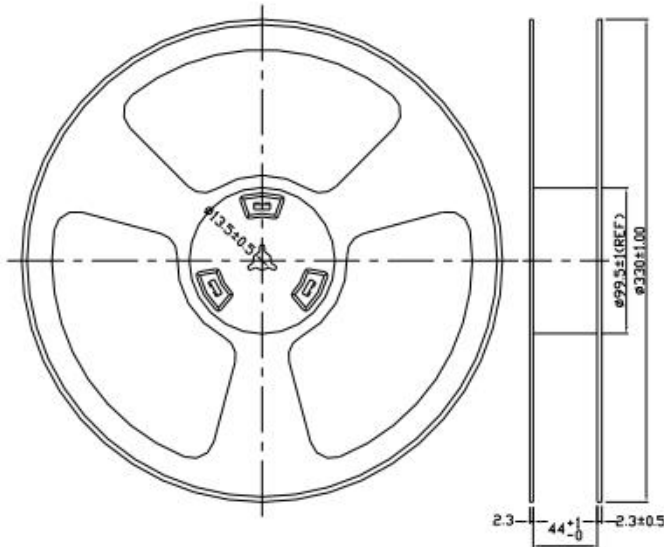


Soldering Iron condition: Soldering iron temperature  $270^\circ\text{C} \pm 10^\circ\text{C}$ .

Apply preheating at  $120^\circ\text{C}$  for 2-3 minutes. Finish soldering for each terminal within 3 seconds, if soldering iron temperature over  $270^\circ\text{C} \pm 10^\circ\text{C}$  or 3 seconds, it will make cause component surface peeling or damage.

# 7. Packaging

200 pcs / reel / inner carton  
 4 reels in an outer carton (800)



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